

(c) a photopolymerization initiator.

3. (amended) A photosensitive film according to Claim 1, wherein the adhesive strength between the photosensitive resin composition-containing photosensitive resin layer (B) and the support film (A) is greater than adhesive strength between the photosensitive resin composition-containing photosensitive resin layer (B) and the protecting film (C).

8. (amended) A photosensitive film according to Claim 2, wherein said binder polymer

C 2 (a) contains a carboxyl group-containing monomer in an amount of 12 to 40% by weight based on the total amount of the monomers, has a weight-average molecular weight of 20,000 to 300,000, and is used in an amount of 40 to 80 parts by weight; wherein said monomer (b) is used in an amount of 20 to 60 parts by weight; and wherein said photopolymerization initiator (c) is used in an amount of 0.1 to 20 parts by weight, based on 100 parts by weight of the total amounts of (a) and (b).

C 3 11. (amended) A photosensitive film according to Claim 2, wherein the monomer (b) is

S 2 bisphenol A polyoxyalkylene dimethacrylate, or contains bisphenol A polyoxyalkylene dimethacrylate as a component.

C 4 15. (amended) A process for laminating a photosensitive film on a substrate having a

metallic surface, which comprises laminating a photosensitive film of Claim 1 on a substrate, while removing the protective film (C) so as to make the photosensitive resin layer (B) adhere to the substrate.

C5 Subd

19. (amended) A photosensitive film comprising a support film, a photosensitive resin layer on said support film, and a film stuck onto said photosensitive resin layer, wherein said film has fish eyes of a diameter of at least 80 μm in a number not exceeding 5 per square meter.

20. (cancelled)

C6 Sub E2

21. (amended) A photosensitive film according to Claim 19, wherein adhesive strength between the photosensitive resin layer and the support film is greater than adhesive strength between the photosensitive resin layer and the film.

22. (amended) A photosensitive film according to Claim 19, wherein the support film has a film thickness of 12 to 25 μm .

23. (amended) A photosensitive film according to Claim 19, wherein the photosensitive resin layer is made from a resin composition comprising:

- (a) a binder polymer formed by copolymerizing acrylic acid or methacrylic acid and alkyl esters thereof as constituent monomers;
- (b) a monomer having at least one polymerizable ethylenically unsaturated group in the molecule thereof; and
- (c) a photopolymerization initiator.

24. (amended) A photosensitive film according to Claim 23, wherein the binder polymer
(a) contains a carboxyl group-containing monomer in an amount of 12 to 40% by weight based
on the total amount of the monomers, has a weight-average molecular weight of 20,000 to
300,000, and is used in an amount of 40 to 80 parts by weight; wherein the monomer (b) is used
in an amount of 20 to 60 parts by weight; and wherein the photopolymerization initiator (c) is
used in an amount of 0.1 to 20 parts by weight, based on 100 parts by weight of the total amounts
of (a) and (b).

Sys 5
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26. (amended) A photosensitive film according to Claim 23, wherein the monomer (b) is
bisphenol A polyoxyalkylene dimethacrylate or contains bisphenol A polyoxyalkylene
dimethacrylate as a component.

Sys 5
C

33. (amended) A process for laminating a photosensitive film on a substrate, which
comprises laminating the photosensitive film of Claim 19 on a substrate, while removing the film
so as to make the photosensitive resin layer adhere to the substrate having a metallic surface.